

SPECIFICATION

NO.:CXT280H02H34-200P50R

ACCEPTED	
ВҮ	
CUSTOMER	

Product: 2.8" TFT 240(RGB) *320 Pixels

Verson: V00

Date: 2014/01/02

APPROVED	CHECKED	PREPARED

深圳市朝显联合光电有限公司

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Shenzhen CX United Opto Electronic Co., Ltd 1. History Verson

		10.00		
Sample verson	Doc. verson	Date	Discription	Modi fy
V00	V00	2014-01-02	First issue	Hai bo_Qi n

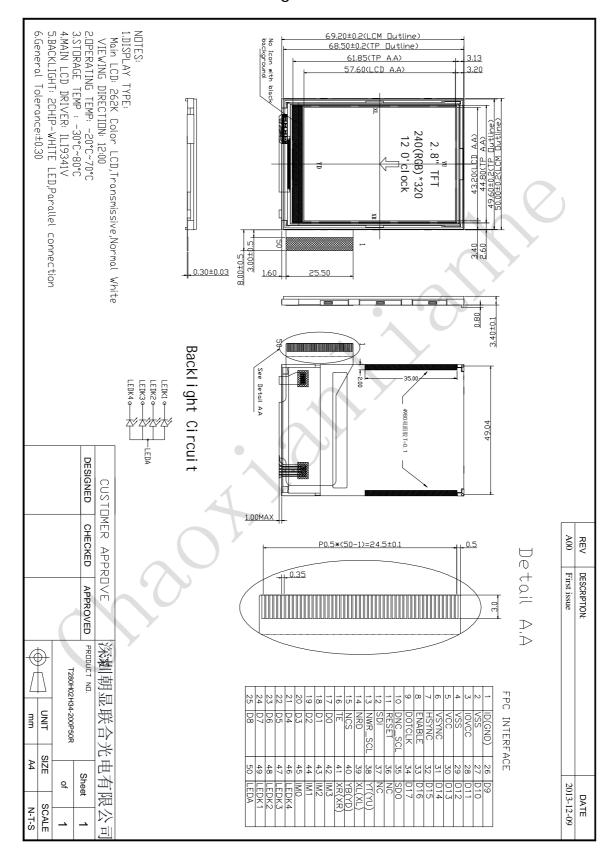


2. Mechanical Description

Name	Content	Uni t
Outline Size	50.00 (W) * 69.20 (H) * 3.4(T)	mm
Module size	2.8 (A.A)	i nch
Resolution	240(RGB)* 320 Pixels	<u>-</u> C
Viewing size	43.20(W) * 57.60(H)	mm
Pixel size	0.180 * 0.180	mm
LCD Type	TFT (262K)/ Transmissive	-
Viewing Angle	12 H	-
Driver IC	TL19341V	-
Backlight Type	4 Parallel LED	-
Interface Type	RGB / MCU /SPI	-



3. Mechanical Drawing





Note 1:

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4. Interface Definition

PIN NO.	PIN Name	Funtion Description		
1	ID(GND)	Ground		
2	VSS	Ground		
3	I OVCC	Power supply for logic.		
4	VSS	Ground		
5	VCC	Power supply for system.		
6	VSYNC	Vertical sync input in RGB mode(short to GND if not used)		
7	HSYNC	Horizontal sync input in RGB mode(short to GND if not used)		
8	ENABLE	Data enable in RGB mode. (short to GND if not used)		
9	DOTCLK	Colock signal in RGB mode. (short to GND if not used)		
10	DNC_SCL	Data/command selection pin in MCU interface.		
11	RESET	Reset pin for system.		
12	SDI	Serial data input in SPI interface.		
13	NWR_SCL	Write signal in MCU interface/clock input in SPI interface.		
14	NRD	Read signal in MCU interface.		
15	NCS	Chip selection signal in MCU interface.		
16	TE	Frame mark output pin.		
17-34	DO-D17	Data bus.		
35	SD0	Serial data output in SPI interface.		
36-37	NC	No connection.		
38	YU	touch panel Y-up		
39	XL	touch panel X-left		
40	YD	touch panel Y-bottom		
41	XR	touch panel X-right		
42	IM3			
43	IM2	Interface selection pin, for detail please see note1.		
44	IM1			
45	I MO			
46-49	LEDK4-LEDK1	back light power supply negative		
50	LEDA	back light power supply positive		

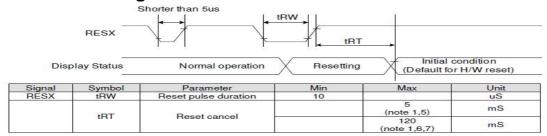


IM3	IM2	IM1	IMO	MCU-Interface Mode	DB Pin in u	ıse
IIVIS	IIVIZ	IIVI	IIVIU	MCO-Interface Mode	Register/Content	GRAM
0	0	0	0	80 MCU 8-bit bus interface I	D[7:0]	D[7:0]
0	0	0	1	80 MCU 16-bit bus interface 1	D[7:0]	D[15:0]
0	0	1	0	80 MCU 9-bit bus interface 1	D[7:0]	D[8:0]
0	0	1	1	80 MCU 18-bit bus interface I	D[7:0]	D[17:0]
0	1	0	1	3-wire 9-bit data serial interface	SDA: In/OUT	
0	1	1	0	4-wire 8-bit data serial interface	SDA: In/OUT	
1	0	0	0	80 MCU 16-bit bus interface ∏	D[8:1]	D[17:10] D[8:1]
1	0	0	1	80 MCU 8-bit bus interface Ⅱ	D[17:10]	D[17:10]
1	0	1	0	80 MCU 18-bit bus interface ∏	D[8:1]	D[17:0]
1	0	1	1	80 MCU 9-bit bus interface Ⅱ	D[17:10]	D[17:9]
1	1	0	1	3-wire 9-bit data serial interface ∏	SDI: In SDO: Out	
1	1	1	0	4-wire 8-bit data serial interface II	SDI: In SDO: Ou	

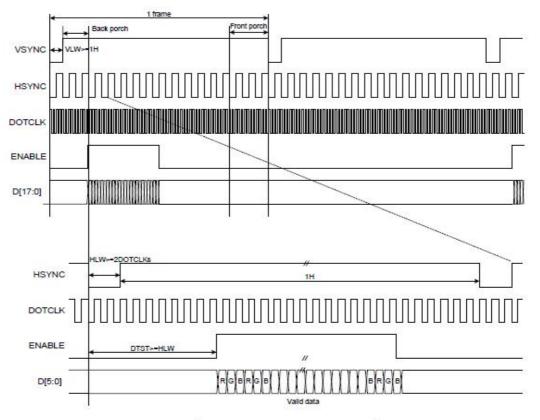


5. Interface Timing:

5.1 Reset Timing



5.2 RGB Interface Timing

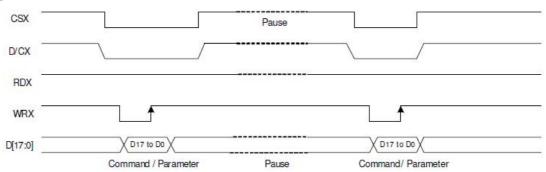


VLW : VSYNC Low Width HLW : HSYNC Low Width DTST : Data Transfer Startup Time

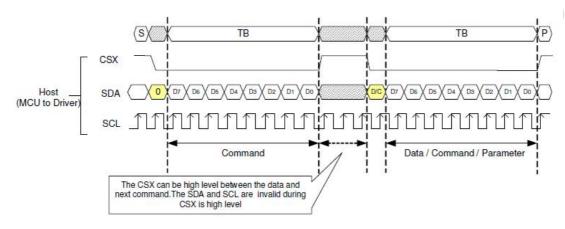
Parameters	Symbols	Condition	Min.	Тур.	Max.	Units
Horizontal Synchronization	Hsync		2	10	16	DOTCLK
Horizontal Back Porch	HBP		2	20	24	DOTCLK
Horizontal Address	HAdr		22	240		DOTCLK
Horizontal Front Porch	HFP		2	10	16	DOTCLK
Vertical Synchronization	Vsync		1	2	4	Line
Vertical Back Porch	VBP		1	2		Line
Vertical Address	VAdr		9	320	-2	Line
Vertical Front Porch	VFP		3	4	- 22	Line

5.3 MCU Interface Timing



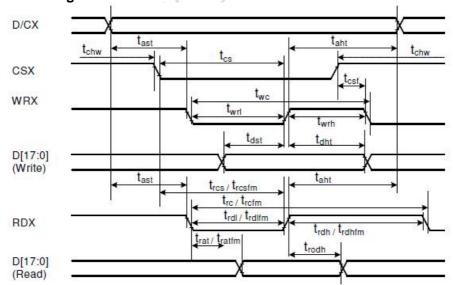


5.4 SPI Interface Timing(3 Wire)



5.5 AC Timing Diagram

1)MCU AC Timing

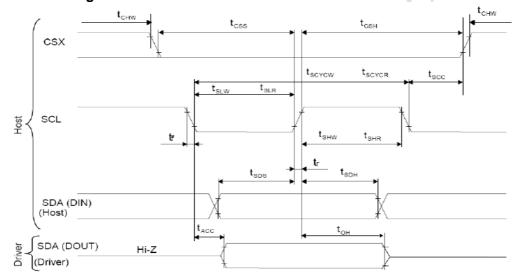




Signal	Symbo	Parameter	min	max	Unit	Description
DOV	tast	Address setup time	0	-	ns	
DCX	taht	Address hold time (Write/Read)	0	-	ns	
	tchw	CSX "H" pulse width	0	24	ns	
	tcs	Chip Select setup time (Write)	15	74	ns	
CSX	trcs	Chip Select setup time (Read ID)	45	B 1	ns	
5508	trcsfm	Chip Select setup time (Read FM)	355	8:	ns	
	tcsf	Chip Select Wait time (Write/Read)	10	20	ns	
T. mari	twc	Write cycle	66		ns	
WRX	twrh	Write Control pulse H duration	15	F	ns	
1111	twrl	Write Control pulse L duration	15	B]	ns	
	trcfm	Read Cycle (FM)	450	-	ns	
RDX (FM)	trdhfm	Read Control H duration (FM)	90	2	ns	
111111111111111111111111111111111111111	trdlfm	Read Control L duration (FM)	355	51	ns	
	trc	Read cycle (ID)	160	2	ns	
RDX (ID)	trdh	Read Control pulse H duration	90	5	ns	
	trdl	Read Control pulse L duration	45	-	ns	
D[17:0]	tdst	Write data setup time	10		ns	
D[17:0], D[17:10]&D[8:1], D[17:10],	tdht	Write data hold time	10	-	ns	For maximum CL=30pF
	trat	Read access time	72	40	ns	For minimum CL=30pF
D[17:10], D[17:9]	tratfm	Read access time	10-93	340	ns	I of fillillillidin oc=opr
2[11.0]	trod	Read output disable time	20	80	ns	

Note: Ta = -30 to 70 ℃, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, VSS=0V.

2)SPI AC Timing

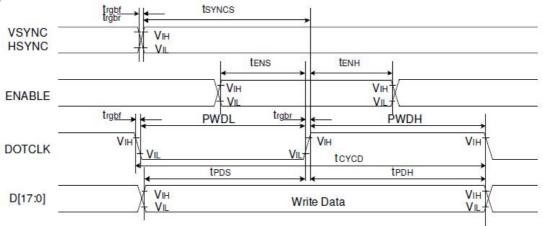


Signal	Symbol	Parameter	min	max	Unit	Description
SCL	tscycw	Serial Clock Cycle (Write)	100	720	ns	
	tshw	SCL "H" Pulse Width (Write)	40		ns	
	tslw	SCL "L" Pulse Width (Write)	40	120	ns	
	tscycr	Serial Clock Cycle (Read)	150	923	ns	
	tshr	SCL "H" Pulse Width (Read)	60	-	ns	
	tsir	SCL "L" Pulse Width (Read)	60	120	ns	
SDA / SDI	tsds	Data setup time (Write)	30	058	ns	
(Input)	tsdh	Data hold time (Write)	30	329	ns	
SDA/SDO	tacc	Access time (Read)	10	572	ns	
(Output)	toh	Output disable time (Read)	10	50	ns	
300 100 100	tscc	SCL-CSX	20	923	ns	
CSX	tchw	CSX "H" Pulse Width	40	383	ns	·
	tcss	CCV CCI Time	60	120	ns	
	tcsh	CSX-SCL Time	65	050	ns	

Note: Ta = 25 °C, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, AGND=VSS=0V

3)RGB AC Timing





Signal	Symbol	Parameter	min	max	Unit	Description
VSYNC/	tsyncs	VSYNC/HSYNC setup time	15	3563	ns	
HSYNC	tsynch	VSYNC/HSYNC hold time	15	1926	ns	
DE	t _{ENS}	DE setup time	15	068	ns]
DE	tenh	DE hold time	15	1926	ns	
tros		Data setup time	15	10:53	ns	18/16-bit bus RGB
D[17:0]	tpDH	Data hold time	15	124	ns	interface mode
	PWDH	DOTCLK high-level period	15	5.5	ns	
DOTCLK	PWDL	DOTCLK low-level period	15	199	ns	
	t _{CYCD}	DOTCLK cycle time	100	- (-)	ns	
	t _{rgbr} , t _{rgbf}	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns	
VSYNC/	tsyncs	VSYNC/HSYNC setup time	15	1926	ns	
HSYNC	tsynch	VSYNC/HSYNC hold time	15	-	ns	
DE	tens	DE setup time	15	575	ns]
DE	t _{ENH}	DE hold time	15	-	ns	
D(17:01	tPOS	Data setup time	15	_ USTA	ns	6-bit bus RGB
D[17:0]	t _{PDH}	Data hold time	15	(198)	ns	interface mode
DOTCLK	PWDH	DOTCLK high-level pulse period	15	725	ns	
	PWDL	DOTCLK low-level pulse period	15	13-33	ns	
DOTOLK	toyon	DOTCLK cycle time	100		ns]
	t _{rgbr} , t _{rgbf}	DOTCLK,HSYNC,VSYNC rise/fall time	8	15	ns	

Note: Ta = -30 to 70 °C, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, AGND=VSS=0V



6. Absolute Maximum Ratings:

Name	symbol	Mi n	Туре	Max	Uni t
Operation Temperature	Тор	-10	-	60	${\mathbb C}$
Storage Temperature	Тѕт	-20	-	70	${\mathbb C}$

7. DC Characteristics

Name	Symbol	Mi n	Туре	Max	Uni t
System Voltage	VCC	2.6	2.8	3.0	V
Logic Voltage	LOVCC	1.8	-	3.3	Y
Input High Voltage	Vih	0.810VCC	-	I OVCC	V
Input Low Voltage	VIL	-0.3	-	0. 21 OVCC	V
Output High Voltage	Vон	0.810VCC		-	V
Output Low Voltage	Vol	-	\(\frac{1}{2}\)	0. 21 OVCC	V
Current Consumption	I CC	- 0	-	25	mA

8. Blacklight:

Name	Min	Туре	Max	Uni t
Current		60	70	mA
Vol tage	\ <u>\</u>	3. 2	3.4	V
Power Consumption	-	192	-	mW
I umi nance	150	200	-	CD/M² (Note1)
Lumi nance uni formi ty	75%	80%	-	(Note2)
X Color Coordinates	0.27	0. 28	0.31	
Y Color Coordinates	0. 27	0. 28	0.31	-

Note1: This luminance is tested with assembling the LCD.



深圳市朝显联合光电有限公司 Shanzhan CX United Onto Flactronic Co. Lt

Shenzhen CX United Opto Electronic Co., Ltd Note2: Definition of Luminance Uniformity.

Active area is divided into 9 measuring areas (Refer to Fig. 4-4). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity (Yu) =
$$\frac{B_{min}}{B_{max}}$$

L-----Active area length W----- Active area width

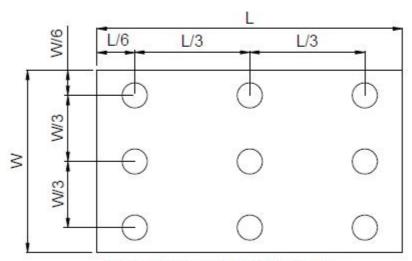


Fig. 4-4 Definition of measuring points

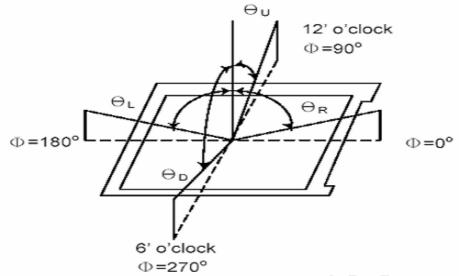
 \mathbf{B}_{max} : The measured maximum luminance of all measurement position. \mathbf{B}_{min} : The measured minimum luminance of all measurement position.

9. Optical Specification

Name Symbol		Min	Туре	Max	Uni t
Transmittance rate	T(%)	-	4.6	1	%
Contrast ratio	C/R	400	500	-	-
Response time	Tr+Tf	-	45	-	ms
	θЦ	40	50	-	
Vi ewi ng	θ D	35	45	-	degree
Angl e	θЦ	35	45	-	(C/R>10)
	θR	10	20	-	

*Vi	ewi	ng	angl	le	descr	ipti	n:





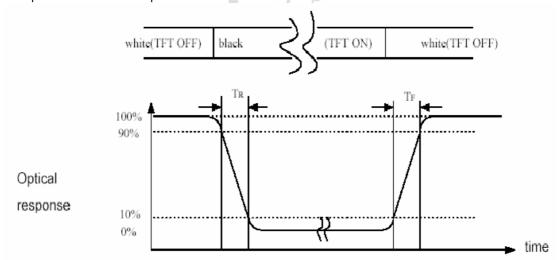
*Contrast rate description(CR) : Tested in the center of the LCM panel

Luminance with all pixels white

CR = ----

Luminance with all pixels black

*Response time description : Sum of TR and TF





10.Touch Panel:

ltem	Description	Uni t
linearity	<1.5%	-
transmi ttance	>80%	-
Response time	<10	ms
Life time	1,000,000	times
Operation pressure	60~100	g
Circuit level	3~15	V



11. Reliability testing:

Item No	Name	Name Condition	
1	High temperature Operating	70°C , 168Hours	Finish product (With polarizer)
2	Low temperature Operating	-20° C , 168 Hours	Finish product (With polarizer)
3	High temperature Storage	80° C , 168 Hours	Finish product (With polarizer)
4	Low temperature Storage	-30° C , 168 Hours	Finish product (With polarizer)
5	High temperature & humidity Storage	60° C , 90%RH, 168 Hours	Finish product (With polarizer)
6	Thermal Shock Storage(No operation)	-20° C , 30min. <=> 70° C , 30min. 10 Cycles	Finish product (With polarizer)
7	ESD test	Voltage:+8KV R:330 ohm,C:150pF Air discharge,10 times	Finish product (With polarizer)
8	Vibration test	$10 \Rightarrow 55 \Rightarrow 10 \Rightarrow 55 \Rightarrow 10 \text{ Hz},$ within 1 minute; Amplitude: 1.5mm. 15 minutes for each Direction (X, Y, Z)	Finish product (With polarizer)
9	Drop test	Packed, 100CM free fall 6 sides, 1 corner, 3edges	Finish product (With polarizer)

^{*}One single product test for only one item.

- Current consumption < 2 times of initial value
- Contrast > 1/2 initial value
- Function: work normally

^{*} Judgment after test: keep in room temperature for more than 2 hours.



12. Inspection Standard

12.1 Defect Defination

No.	Defect Class	Defination	Content
1	重缺陷 (MA)	一 一	短路、断路、缺划、大电流、视角错、 漏液、显示不清等
		严重外观缺陷	产品尺寸不符、漏部品等
2	轻缺陷(MI)	不影响产品功能,但 对产品外观有影响	反黑 / 反白点、偏光片缺陷、针 孔、污点

12.2 Standard

			Classifi
No.	Item	Inspection Standard	cation
NO.	i telli	riispectroii Stanuaru	of
			defects

1	显示状态	不显、显示乱码、多划、少划、少画面、视角错、闪烁等均不允许 无法用文字描述的现象,必要时制定限度样板进行参考。如:显示不均、显示 浓淡、斜纹等 显示的颜色效果参照开发、工程样品或按限度样板判定	重缺陷
		画面切换过程中可见(但非画异)之不良现象(暂停画面时不良现 象不可见)不作管控,客户有特殊要求时依客户要求;	轻缺陷
		仅点背光不显示画面下可见不良现象(但显示画面时不良现象不可见)不作管控,客户有特殊要求时依客户要求;	轻缺陷
		LED 灯不亮或闪烁不稳定不允许	重缺陷
		背光电流:超出规格范围不允许	
2	背光	亮眼、漏光: 进入 LCD 的 A、B 区不允许,必要时按限度样板做判定	轻缺陷
		背光颜色: 根据样品、规格书判定	轻缺陷
		亮度与发光均匀度参照开发、工程或限度样板判定	轻缺陷



No.	ltem	Inspection Standard	Classifi cation of defects
3	显示黑点 白点 针孔	直径 (Φ= (X+Y) /2)	轻缺陷
4	显示黑线 白线	尺 寸 (L: 线长; W: 线宽) 允收数 图示 L 不计 W<0.03 (密集不可) 不计 L≤2 0.03≤W≤0.05 [注 2] 2 L 不计 W>0.05 注1. 包括: 显示黑线、白线、线状异物。 注2. 单个产品不允许超过2个线状缺陷,且 缺陷距离必须大于10mm以上。	轻缺陷
5	触摸屏	点击触摸屏测试点画面无转换不 允许	重缺陷

13. Precaution

13.1 Handling

- (1) Protect the panel from static, it may cause damage to the CMOS Gate Array IC.
- (2) Use fingerstalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.
- (3) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs or clothes, it must be washed away thoroughly with soap.
- (4) The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane. Don't use Ketone type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.

(5)	Pins of I/F	connector	shall not b	e touched	directly	with bare	hands.
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- (6) Refrain from strong mechanical shock and / or any force to the panel. In addition to damage, this may cause improper operation or damage to the panel.
- (7) Note that polarizers are very fragile and could be easily damaged. Do not press or scratch the surface harder than a B pencil lead.
- (8) Wipe off water droplets or oil immediately. If you leave the droplets for a long time, staining and discoloration may occur.
 - (9) If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.

13.2 Storage

- (1) Do not leave the panel in high temperature, and high humidity for a long time. It is highly recommended to store the panel with temperature from 0 to 35° C and relative humidity of less than 70%.
- (2) The panel shall be stored in a dark place. It is prohibited to apply sunlight or fluorescent light during the store.

13.3 Operation

- (1) The LCD shall be operated within the limits specified. Operation at values outside of these limits may shorten life, and/or harm display images.
- (2) Do not exceed the absolute maximum rating value. (the supply voltage variation,Input voltage variation in part contents and environmental temperature and so on).Otherwise the panel may be damaged.
- (3) If the panel displays the same pattern continuously for a long period of time, it can be the situation when the image" Sticks" to the screen.